CREATEK Microelectronics

Ultra` Low Capacitance ESD Protection Diode in \$* \$'

Features

- ESD protection for high speed data lines to IEC61000-4-2
- ESD contact discharge typical 8KV, max 15KV
- ESD air discharge typical 15KV, max 25KV
- Surface mount
- Extremely low capacitance
- Very low leakage current
- Fast response time
- Bi-directional ESD protection
- Lead free solder termination
- The best ESD protection for high frequency, low voltage applications



■ Case: €Î €H(plastic package). Lead free; RoHS compliant

■ Molding Compound Flammability Rating: UL 94 V-0

■ **Terminals:** High temperature soldering guaranteed: 260 °C/10 sec. at terminals

Absolute Maximum Ratings

Ratings at 25 °C, ambient temperature unless otherwise specified

Parameter	Symbol	Value	Unit
Maximum Contact discharge voltage Per IEC61000-4-2		15KV	V
Maximum Air discharge voltage Per IEC61000-4-2		25KV	V
Maximum Operating temperature	Toper	-40 to +90	℃
Maximum Storage temperature	Тѕтѕ	-55 to +125	℃
Maximum lead temperature for soldering during 10s	TL	260	℃

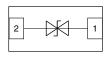
Electrical Characteristics

(T_A = 25 °C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Rated Voltage	VR				16	V
Trigger voltage	VT	IEC61000-4-2 8KV contact discharge		350		V
Clamping voltage	Vc	IEC61000-4-2 8KV contact discharge		35		V
Leakage current	l _L	DC 12V shall be applied on component			0.10	uA
Capacitance	СР	V _R = 0V, f = 1MHz		0.05		pF

Note: 1 Trigger and clamping voltage are measured per IEC 61000-4-2, 8KV contact discharge method.

2 After reliability tests such as high temp storage, temp cycles, continuous ESD strike etc, the maximum leakage current is less than 10uA.



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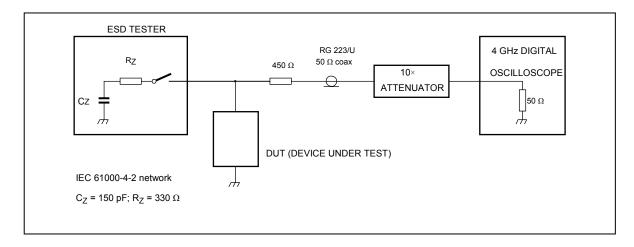
Applications

- USB3.0, Firewire, DVI, HDMI, S-ATA
- Thunderbolt, Display Port
- Mobile HDMI Link, MDDI, MIPI, SWP / NFC



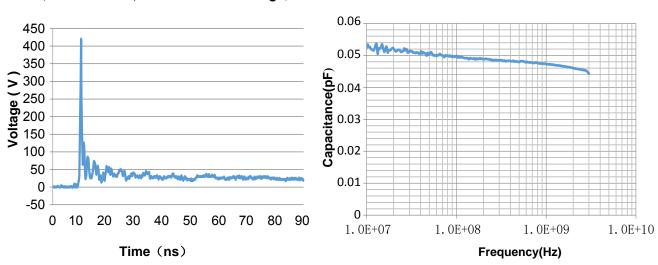
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ESD Clamping Test



Typical ESD Response (IEC 61000-4-2, 8KV contact discharge)

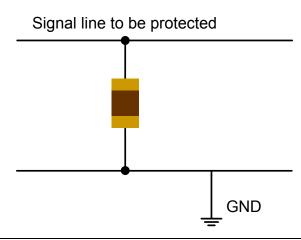
Typical Device Capacitance VS. Frequency



ESD Protection for Signal Line

The CESD is designed for the protection of one bidirectional data line from ESD damage.

- Place the CESD as close to the input terminal or connector as possible.
- Minimize the path length between the CESD and the protected signal line.
- Use ground planes whenever possible.

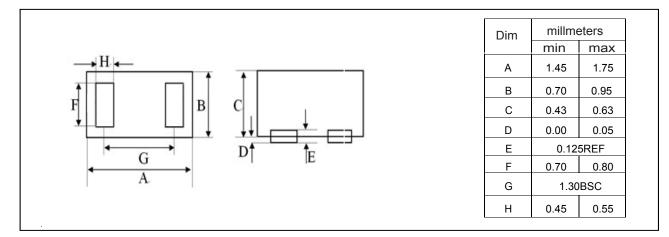


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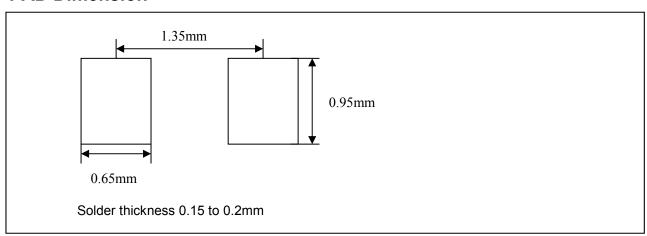


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Product Dimension



PAD Dimension



Ordering inormation

Order code	Package	Packaging option	Base quantity	Packaging specification
CESDP0603UC16VB	0603	Tape and reel	5000pcs / reel	EIA STD RS-481

Revision history

Date	Revision	Changes
23-May-2012	1.0	Initial release

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CESDP0603UC16VB

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